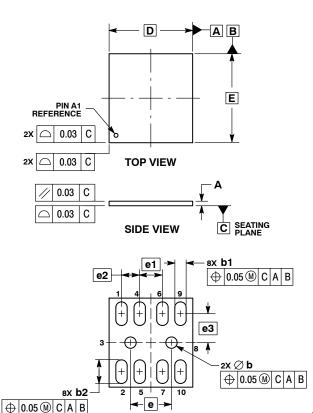






## WLCSP10 1.84x1.96x0.10 CASE 567PH ISSUE A

**DATE 06 APR 2017** 



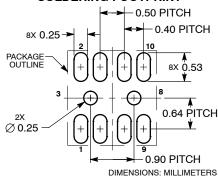
**BOTTOM VIEW** 

## NOTES:

- DIMENSIONING AND TOLERANCING PER
  ASME Y14 5M 1994
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.08	0.10	0.12	
b	0.22	0.25	0.28	
b1	0.22	0.25	0.28	
b2	0.50	0.53	0.56	
D	1.84 BSC			
E	1.96 BSC			
е	0.90 BSC			
e1	0.50 BSC			
e2	0.40 BSC			
е3	0.64 BSC			

## RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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